

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Package Options Include Plastic Small-Outline (DB) Packages and Plastic 300-mil DIPs (N)

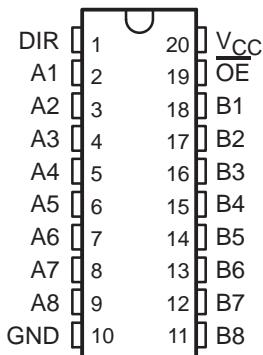
### description

The SN74F2245 is designed for asynchronous communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the logic level at the direction-control (DIR) input. The output-enable ( $\overline{OE}$ ) input disables the device so the buses are effectively isolated.

Both A and B outputs can sink up to 12 mA; 25- $\Omega$  resistors are included in the lower output circuit to reduce overshoot and undershoot.

The SN74F2245 is characterized for operation from 0°C to 70°C.

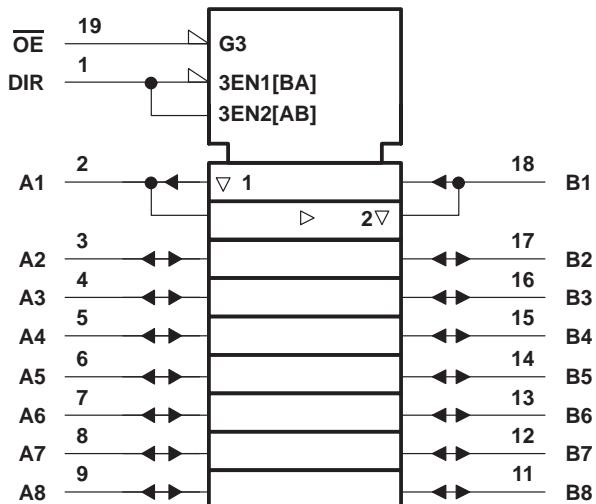
DB OR N PACKAGE  
(TOP VIEW)



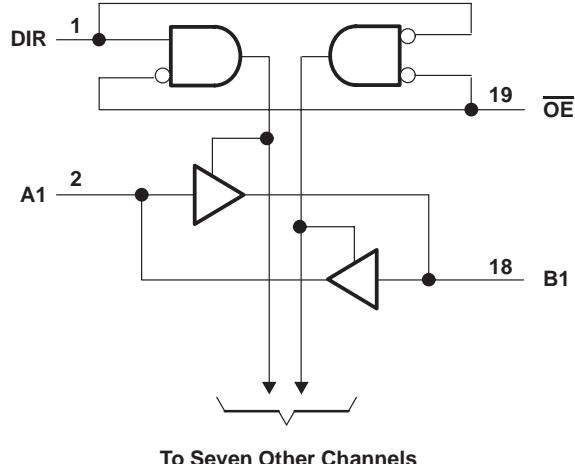
FUNCTION TABLE

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

### logic symbol†



### logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**SN74F2245**  
**25- $\Omega$  OCTAL BUS TRANSCEIVER**  
**WITH 3-STATE OUTPUTS**

SDF099 – MAY 1995

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

Supply voltage range, $V_{CC}$ .....	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1) .....	–1.2 V to 7 V
Input current range .....	–30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state .....	–0.5 V to 5.5 V
Voltage range applied to any output in the high state .....	–0.5 V to $V_{CC}$
Current into any output in the low state .....	30 mA
Operating free-air temperature range, $T_A$ .....	0°C to 70°C
Storage temperature range, $T_{stg}$ .....	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

**recommended operating conditions**

		MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
$I_{IK}$	Input clamp current			–18	mA
$I_{OH}$	High-level output current			–3	mA
$I_{OL}$	Low-level output current			12	mA
$T_A$	Operating free-air temperature	0		70	°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS		MIN	TYP <sup>‡</sup>	MAX	UNIT
$V_{IK}$		$V_{CC} = 4.5$ V, $I_I = –18$ mA				–1.2	V
$V_{OH}$	Any output	$V_{CC} = 4.5$ V	$I_{OH} = –1$ mA	2.5	3.4		V
			$I_{OH} = –3$ mA	2.4	3.3		
		$V_{CC} = 4.75$ V,	$I_{OH} = –1$ mA to –3 mA	2.7			
$V_{OL}$	Any output	$V_{CC} = 4.5$ V	$I_{OL} = 1$ mA	0.2	0.5		V
			$I_{OL} = 12$ mA	0.5	0.75		
$I_I$	A and B	$V_{CC} = 5.5$ V	$V_I = 5.5$ V			1	mA
	DIR and OE		$V_I = 7$ V			0.1	
$I_{IH}^§$	A and B	$V_{CC} = 5.5$ V,	$V_I = 2.7$ V			70	$\mu$ A
	DIR and OE					20	
$I_{IL}^§$	A and B	$V_{CC} = 5.5$ V,	$V_I = 0.5$ V			–0.5	mA
	DIR and OE					–0.5	
$I_{OS}^¶$	A and B	$V_{CC} = 5.5$ V,	$V_O = 0$	–50		–120	mA
$I_{CC}$		$V_{CC} = 5.5$ V	Outputs high		62	90	mA
			Outputs low		73	105	
			Outputs disabled		72	100	

<sup>‡</sup> All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$ .

<sup>§</sup> For I/O ports, the parameters  $I_{IH}$  and  $I_{IL}$  include the off-state output current.

<sup>¶</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

switching characteristics (see Figure 1)

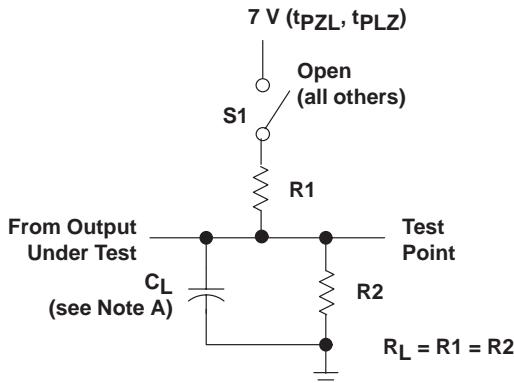
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 5\text{ V}$ , $C_L = 50\text{ pF}$ , $R1 = 500\text{ }\Omega$ , $R2 = 500\text{ }\Omega$ , $T_A = 25^\circ\text{C}$			UNIT	
			MIN	TYP	MAX		
$t_{PLH}$	A or B	B or A	2.5	3.9	5.5	2.1	6.6
$t_{PHL}$			3.1	4.6	6.6	2.9	7.1
$t_{PZH}$	$\overline{OE}$	A or B	2.4	4.8	7.3	1.6	8.5
$t_{PZL}$			3.6	6.6	10.6	3	12
$t_{PHZ}$	$\overline{OE}$	A or B	2.3	4.3	6.3	2	7.5
$t_{PLZ}$			2	4	5.8	1.9	6.8

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

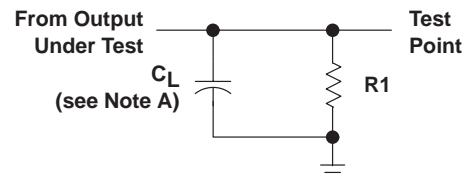
**SN74F2245**  
**25- $\Omega$  OCTAL BUS TRANSCEIVER**  
**WITH 3-STATE OUTPUTS**

SDFS099 – MAY 1995

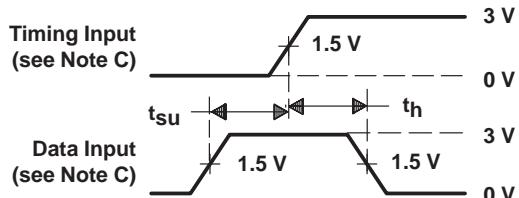
**PARAMETER MEASUREMENT INFORMATION**



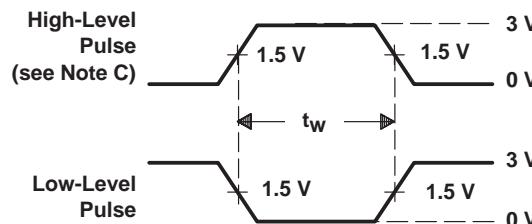
LOAD CIRCUIT FOR  
 3-STATE AND OPEN-COLLECTOR OUTPUTS



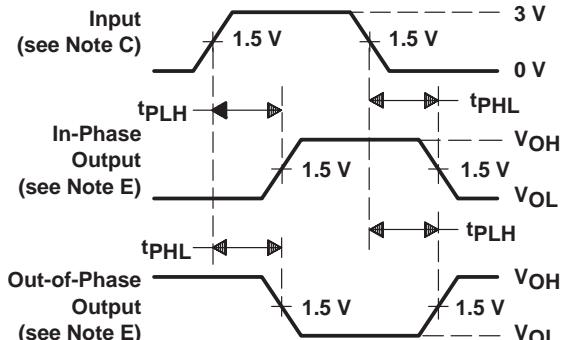
LOAD CIRCUIT FOR  
 TOTEM-POLE OUTPUTS



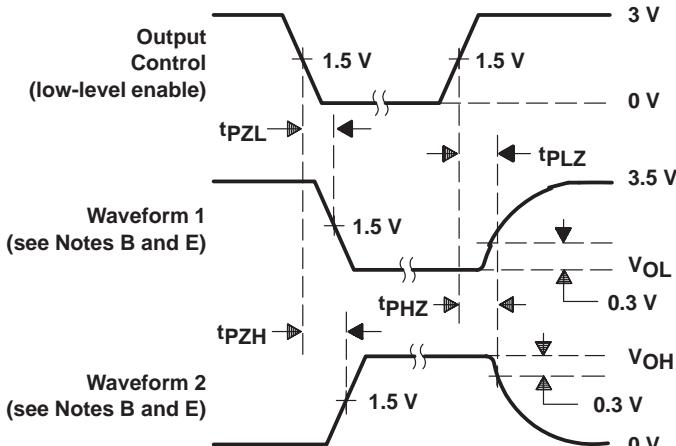
VOLTAGE WAVEFORMS  
 SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
 PULSE DURATION



VOLTAGE WAVEFORMS  
 PROPAGATION DELAY TIMES (see Note D)



VOLTAGE WAVEFORMS  
 ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1$  MHz,  $t_r = t_f \leq 2.5$  ns, duty cycle = 50%.  
 D. When measuring propagation delay times of 3-state outputs, switch S1 is open.  
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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